DATA SHEET

MOS FIELD EFFECT TRANSISTOR μ**PA2725T1A**

SWITCHING N-CHANNEL POWER MOSFET

DESCRIPTION

NEC

The μ PA2725T1A is N-channel MOSFET designed for DC/DC converter applications.

FEATURES

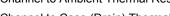
- · Low on-state resistance
- $R_{DS(on)1} = 5.0 \text{ m}\Omega \text{ MAX.}$ (Vgs = 10 V, ID = 13 A)
- $R_{DS(on)2} = 7.5 \text{ m}\Omega \text{ MAX.} (V_{GS} = 4.5 \text{ V}, \text{ ID} = 13 \text{ A})$
- · Low input capacitance

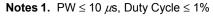
Ciss = 2580 pF TYP. (VDS = 15 V, VGS = 0 V)

- · Built-in gate protection diode
- Thin type surface mount package with heat spreader (8-pin HVSON)
- RoHS Compliant

ABSOLUTE MAXIMUM RATINGS (TA = 25°C, All terminals are connected.)

Drain to Source Voltage (Vgs = 0 V)	VDSS	30	V
Gate to Source Voltage (VDs = 0 V)	Vgss	±20	V
Drain Current (DC)	D(DC)	±25	А
Drain Current (pulse) ^{Note1}	D(pulse)	±150	А
Total Power Dissipation Note2	Pt1	1.5	W
Total Power Dissipation (PW = 10 sec) ^{Note2}	Pt2	4.6	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55 to +150	°C
Single Avalanche Current Note3	las	25	А
Single Avalanche Energy Note3	Eas	62	mJ
THERMAL RESISTANCE			
Channel to Ambient Thermal Resistance Note2	Rth(ch-A)	83.3	°C/W
Channel to Case (Drain) Thermal Resistance	Rth(ch-C)	1.5	°C/W





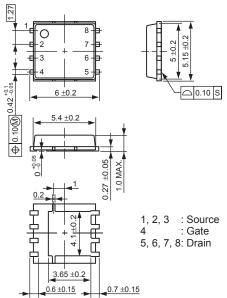
- 2. Mounted on a glass epoxy board of 25.4 mm x 25.4 mm x 0.8 mm
- 3. Starting T_ch = 25°C, V_DD = 15 V, R_G = 25 Ω , V_GS = 20 \rightarrow 0 V, L = 100 μ H

Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

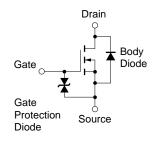
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PACKAGE DRAWING (Unit: mm)



EQUIVALENT CIRCUIT



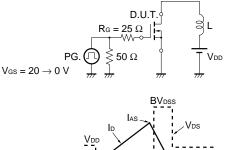
CHARACTERISTICS	SYMBOL	TEST CONDITIONS MIN.		TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	IDSS	V _{DS} = 30 V, V _{GS} = 0 V			10	μA
Gate Leakage Current	Igss	V _{GS} = ±16 V, V _{DS} = 0 V			±10	μA
Gate to Source Cut-off Voltage	V _{GS(off)}	V _{DS} = 10 V, I _D = 1 mA	1.5		2.5	V
Forward Transfer Admittance Note	y _{fs}	V _{DS} = 10 V, I _D = 13 A	9			S
Drain to Source On-state Resistance Note	RDS(on)1	V _{GS} = 10 V, I _D = 13 A		3.8	5.0	mΩ
	RDS(on)2	Vgs = 4.5 V, Id = 13 A		5.5	7.5	mΩ
Input Capacitance	Ciss	V _{DS} = 15 V,		2580		pF
Output Capacitance	Coss	V _{GS} = 0 V,		510		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		200		pF
Turn-on Delay Time	td(on)	Vdd = 15 V, Id = 13 A,		17		ns
Rise Time	tr	V _{GS} = 10 V,		13		ns
Turn-off Delay Time	t _{d(off)}	R _G = 10 Ω		74		ns
Fall Time	tr			17		ns
Total Gate Charge	QG	V _{DD} = 15 V,		22		nC
Gate to Source Charge	QGS	V _{GS} = 5 V,		7.3		nC
Gate to Drain Charge	Qgd	ID = 25 A		7.1		nC
Body Diode Forward Voltage Note	VF(S-D)	IF = 25 A, VGS = 0 V		0.81		V
Reverse Recovery Time	trr	I⊧ = 25 A, V₀s = 0 V,		35		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/ <i>µ</i> s		35		nC
Gate Resistance	Rg	f = 1 MHz		2.2		Ω

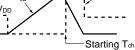
ELECTRICAL CHARACTERISTICS (TA = 25°C, All terminals are connected.)

Note Pulsed

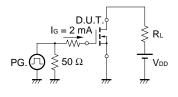
TEST CIRCUIT 1 AVALANCHE CAPABILITY

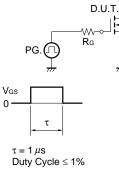
TEST CIRCUIT 2 SWITCHING TIME

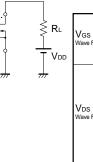


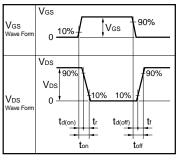


TEST CIRCUIT 3 GATE CHARGE

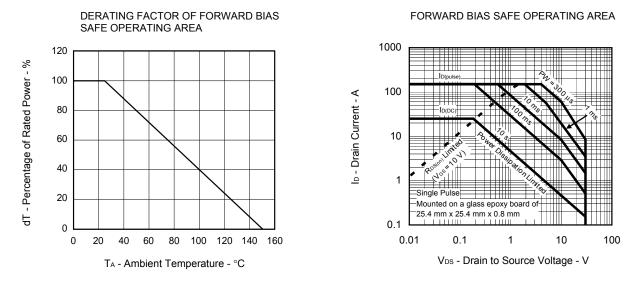




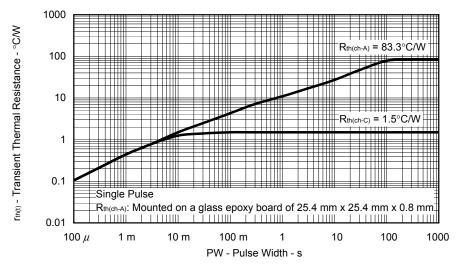




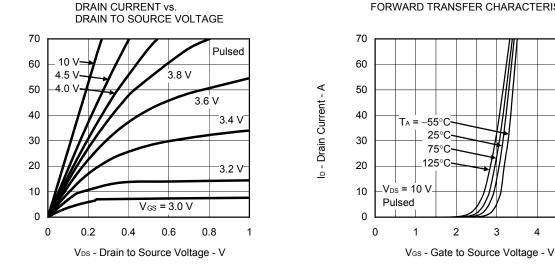
TYPICAL CHARACTERISTICS (TA = 25°C)



TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH





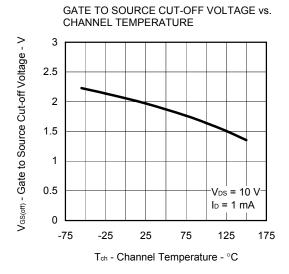


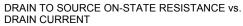
FORWARD TRANSFER CHARACTERISTICS

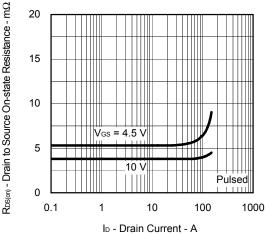
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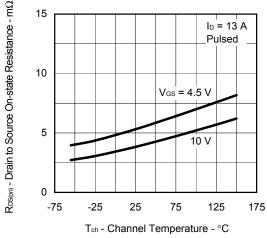
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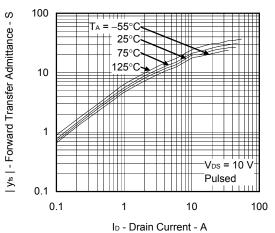




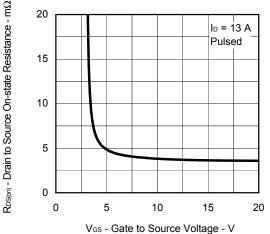




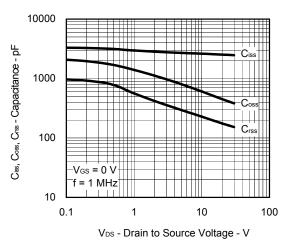
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

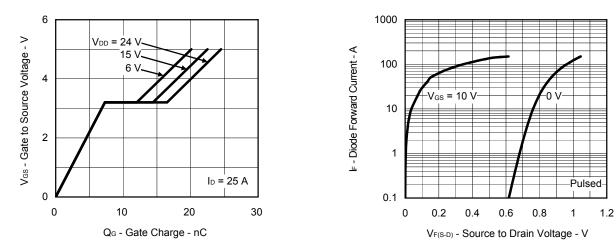


CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



DYNAMIC INPUT/OUTPUT CHARACTERISTICS

SOURCE TO DRAIN DIODE FORWARD VOLTAGE



ORDERING INFORMATION

PART NUMBER	LEAD PLATING	PACKING	PACKAGE	
μΡΑ2725Τ1Α-Ε1-ΑΖ ^{Note}				
μΡΑ2725Τ1Α-Ε2-ΑΖ ^{Note}	Sn-Bi		8-pin HVSON 0.10 g TYP.	
μΡΑ2725Τ1Α-Ε1-ΑΥ ^{Νote}		Tape 3000 p/reel		
μ PA2725T1A-E2-AY ^{Note}	Pure Sn			

Note Pb-free (This product does not contain Pb in the external electrode.)

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